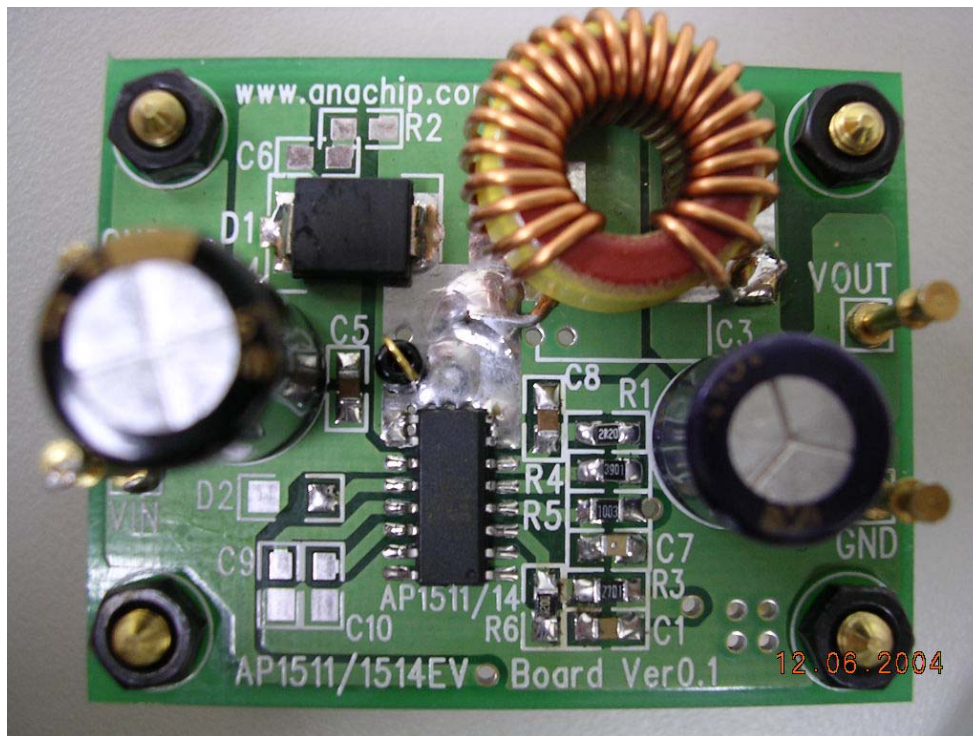


Application Note  
AP1511/AP1514 300KHz 5A PWM Buck DC/DC Converter

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## Contents

1. Features
2. Introduction
3. Regulator Design Procedure
4. Design Example



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**1.0 Features**

- ◆ Small Board Size
  - Entire circuit can fit in less than 1 square inch of PCB space
- ◆ Low Implementation Cost
  - Fewer than 4 discrete components required
- ◆  $\overline{ON}$ /OFF Control
  - Be controlled by external logic level signal
- ◆ Thermal Shut-down and Current Limit
  - Thermal Shutdown function built in and current limit level can be set by outside resistor
- ◆ Simple Feedback Compensation
  - Lead compensation using external capacitor
- ◆ Immediate Implementation
  - Schematic, board-of-materials and board layout available from Anachip

**2.0 Introduction**

This application note discusses simple ways to select all necessary components to implement a step-down (BUCK) regulator and gives a design example. In this example, the AP1511/AP1514 monolithic IC is used to design a cost-effective and high-efficiency miniature switching buck regulator. Please refer to the datasheet for more complete information, pin descriptions and specifications for the AP1511/AP1514 as they will not be repeated here.

This demonstration board allows the designer to evaluate the performance of the AP1511/AP1514 buck regulator in a typical application circuit. The user needs only to supply an input voltage and a load. The demonstration board can be configured to evaluate an adjustable output voltage setting by two resistors. Operation at different voltages and currents may be accomplished by proper component selection and replacement.

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**3.0 Regulator Design Procedure****3.0.1 Given Power Specification** $V_{IN(max)}$  = Maximum Input Voltage $V_{IN(min)}$  = Minimum Input Voltage $V_{OUT}$  = Regulated Output Voltage $V_{RIPPLE}$  = Ripple Voltage (peak-to-peak), typical value is 0.6% of the output voltage $I_{LOAD(max)}$  = Maximum Load Current $I_{LOAD(min)}$  = Minimum Load Current before the circuit becomes discontinuous, typical value is 10% of the Maximum Load Current $F$  = Switching Frequency (fixed at a nominal 300 KHz)**3.0.2 Programming Output Voltage (refer to 4.0.4 Demo Board Schematic P7)**

The output voltage is programmed by selection of the divider R3 and R6. The designer should use resistors R3 and R6 with  $\pm 1\%$  tolerance in order to obtain best accuracy of the output voltage. The output voltage can be calculated from the following formula:

$$V_{OUT} = 0.8 \times (1 + R3 / R6)$$

Select a value for R6 between 1K $\Omega$  and 10K $\Omega$ . The lower resistor values minimize noise pickup in the sensitive feedback pin.

**3.0.3 Programming Current Limit Level (refer to 4.0.4 Demo Board Schematic P7)**

Select a value for R4 to set the current limit level by using this formula:

$$I_{LOAD} \times R_{DS(on)} = I_{OCSET} \times R_{OCSET}$$

In this application we use R4 to be the R<sub>OCSET</sub> and in the example we use 2.7K resistor, the R<sub>DS(ON)</sub> is 40m $\Omega$  and the I<sub>OCSET</sub> is 90uA, so we limit the maximum load current to 6A.

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**3.0.4 Inductor Selection**

A. The minimum inductor  $L_{(min)}$  can be calculated from the following design formula table:

Calculation	Step-down (buck) regulator
Duty	$\frac{(V_{OUT} + V_F)}{V_{IN(min)} - V_{SAT} + V_F}$
$\frac{T_{ON}}{T_{OFF}}$	$\frac{(V_{OUT} + V_F)}{V_{IN(min)} - V_{SAT} - V_{OUT}}$
$L_{(min)}$	$\frac{[V_{IN(min)} - V_{SAT} - V_{OUT}] \times T_{ON(max)}}{2 \times I_{LOAD(min)}}$

$$V_{SAT} = \text{Internal switch saturation voltage of the AP1511/AP1514} = I_{LOAD} \times R_{DS(on)} \text{ V}$$

$$V_F = \text{Forward voltage drop of output rectifier D1} = 0.5\text{V}$$

B. The inductor must be designed so that it does not saturate or significantly saturate at DC current bias of  $I_{PK}$ . ( $I_{PK} = \text{Peak inductor or switch current} = I_{LOAD(max)} + I_{LOAD(min)}$ )

**3.0.5 Output Capacitor Selection**

A. The Output Capacitor is required to filter the output and provide regulator loop stability. When selecting an Output Capacitor, the important capacitor parameters include the 100kHz Equivalent Series Resistance (ESR), the RMS ripples current rating, voltage rating, and capacitance value. For the output capacitor, the ESR value is the most important parameter. The ESR can be calculated from the following formula:

$$ESR = \left( \frac{V_{RIPPLE}}{2 \times I_{LOAD(min)}} \right) \text{-----} (3)$$

An aluminum electrolytic capacitor's ESR value is related to the capacitance and its voltage rating. In most cases, higher voltage electrolytic capacitors have lower ESR values. Most of the time, capacitors with much higher voltage ratings may be needed to provide the low ESR values required for low output ripple voltage. If the selected capacitor's ESR is extremely low, it results in an oscillation at the output. It is recommended to replace this low ESR capacitor by using two general standard capacitors in parallel.

B. The capacitor voltage rating should be at least 1.5 times greater than the output voltage, and often much higher voltage ratings are needed to satisfy the low ESR requirements needed for low output ripple voltage.

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**3.0.6 Output Rectifier Selection**

- A. The current rating of the output rectifier D1 must be greater than the peak switch current  $I_{PK}$ . The reverse voltage rating of the output rectifier D1 should be at least 1.25 times the maximum input voltage.
- B. The output rectifier D1 must be fast (short reverse recovery time) and must be located close to the AP1511/AP1514 using short leads and short printed circuit traces. Because of their fast switching speed and low forward voltage drop, Schottky diodes provide the best performance and efficiency, and should be the first choice, especially in low output voltage applications.

**3.0.7 Input Capacitor Selection**

- A. The RMS current rating of the input capacitor can be calculated from the following formula table. The capacitor manufactured by datasheet must be checked to assure that this current rating is not exceeded.

Calculation	Step-down (buck) regulator
$\delta$	$T_{on}/(T_{on} + T_{off})$
$I_{PK}$	$I_{LOAD(max)} + I_{LOAD(min)}$
$I_m$	$I_{LOAD(max)} - I_{LOAD(min)}$
$\Delta I_L$	$2 \times I_{LOAD(min)}$
$I_{IN(rms)}$	$\sqrt{\delta \times \left[ (I_{PK} \times I_m) + \frac{1}{3} (\Delta I_L)^2 \right]}$

- B. This capacitor should be located close to the IC using short leads and the voltage rating should be approximately 1.5 times the maximum input voltage.

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#### 4.0 Design Example

##### 4.0.1 Summary of Target Specifications

Input Power	$V_{IN(max)} = +12V; V_{IN(min)} = +12V$
Regulated Output Power	$V_{OUT} = +5V; I_{LOAD(max)} = 5A; I_{LOAD(min)} = 0.5A$
Output Ripple Voltage	$V_{RIPPLE} \leq 50 \text{ mV peak-to-peak}$
Output Voltage Load Regulation	0.6% (0.5A to 5A)
Efficiency	87% minimum at full load
Switching Frequency	$f = 300kHz \pm 15 \%$

##### 4.0.2 Calculating and Components Selection

Calculation Formula	Select Condition	Component spec.
$V_{out} = V_{ref} \times ((R3/R6) + 1)$	$1K\Omega \leq R6 \leq 10K\Omega$	$R6 = 1.3K\Omega; R3 = 6.8K\Omega$
$L_{(min)} \geq \frac{V_{IN(min)} - V_{SAT} - V_{OUT}}{2 \times I_{LOAD(min)}} \times T_{ON(max)}$	$L_{(min)} \geq 9.7\mu H$	Select L1 = 10~15uH
$ESR = \left( \frac{V_{RIPPLE}}{2 \times I_{LOAD(min)}} \right)$ $V_{WVDC} \geq 1.5 \times V_{OUT}$	$ESR \leq 125m\Omega$ $V_{WVDC} \geq 7.5V$	Select C3 470uF/10V*1pcs
$V_{RRM} \geq 1.25 \times V_{IN(max)}$	$V_{RRM} \geq 15V$	Select D1: 20V/5A
$I_{IN(rms)} = \sqrt{\delta \times \left[ (I_{PK} \times I_m) + \frac{1}{3} (\Delta I_L)^2 \right]}$ $V_{WVDC} \geq 1.5 \times V_{IN(max)}$	$I_{ripple} \geq I_{IN(rms)} = 3.23A$ $V_{WVDC} \geq 18V$	Select C4 680uF/35V*1pcs

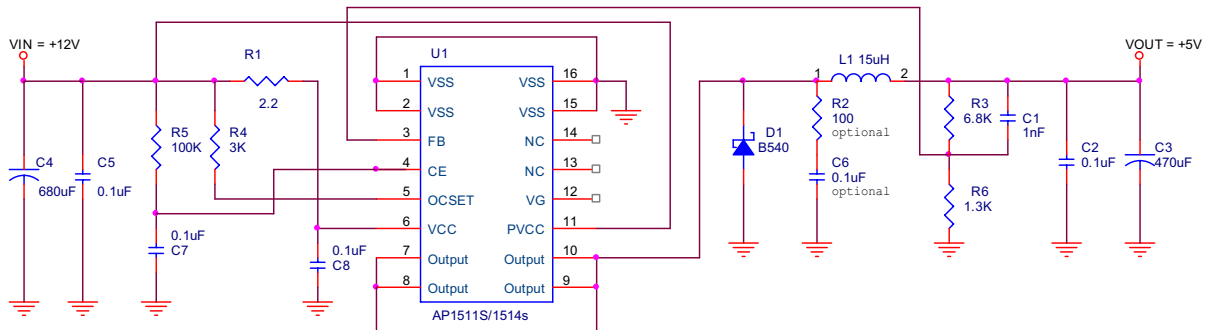
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#### 4.0.3 Parts List (Board of Materials)

Item	Part Number	MFG/Dist.	Description	Value	Quantity
C1	0805 cap	Viking	Ceramic Capacitor	1nF, 25V	1
C2	0805 cap	Viking	Ceramic Capacitor	0.1uF, 25V	1
C3		OST	Aluminum Electrolytic	470uF, 10V	1
C4		OST	Aluminum Electrolytic	680uF, 25V	1
C5	0805 cap	Viking	Ceramic Capacitor	0.1uF, 25V	1
C6	Optional				
C7	0805 cap	Viking	Ceramic Capacitor	0.1uF, 25V	1
C8	0805 cap	Viking	Ceramic Capacitor	0.1uF, 25V	1
D1	B540		Schottky Diode	40V, 5A	1
L1			Inductor	15uH, 5A	1
U1	AP1511/AP1514	Anachip	PWM Buck Converter	300kHz, 5A	1
R1	0805 reg	Viking	Film Chip Resistor	2.2Ω	1
R2	Optional				
R3	0805 reg	Viking	Film Chip Resistor	6.8KΩ	1
R4	0805 reg	Viking	Film Chip Resistor	2.7KΩ	
R5	0805 reg	Viking	Film Chip Resistor	100KΩ	1
R6	0805 reg	Viking	Film Chip Resistor	1.3KΩ	1

#### 4.0.4 Demo Board Schematic



$$V_{OUT} = 0.8 \times (1 + R3 / R6)$$

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**4.0.5 Demo Board Efficiency and Temperature**

$V_{in}$ (V)	$I_{in}$ (A)	$V_{out}$ (V)	$I_{out}$ (A)	Efficiency (%)
12.00	0.254	5.059	0.5	82.90%
12.00	0.483	5.056	1.0	87.30%
12.00	0.941	5.036	2.0	89.18%
12.00	1.411	5.025	3.0	89.02%
12.00	1.888	5.008	4.0	88.38%
12.00	2.376	4.987	5.0	87.41%

$V_{in}$ (V)	$I_{in}$ (A)	$V_{out}$ (V)	$I_{out}$ (A)	Efficiency (%)
12.00	0.181	3.336	0.5	76.78%
12.00	0.335	3.333	1.0	83.01%
12.00	0.657	3.323	2.0	84.32%
12.00	0.988	3.314	3.0	83.85%
12.00	1.327	3.303	4.0	82.94%
12.00	1.677	3.293	5.0	81.79%

$V_{in}$ (V)	$I_{in}$ (A)	$V_{out}$ (V)	$I_{out}$ (A)	Efficiency (%)
5.00	0.362	3.295	0.5	91.15%
5.00	0.715	3.289	1.0	92.03%
5.00	1.443	3.282	2.0	91.00%
5.00	2.198	3.272	3.0	89.28%
5.00	2.982	3.257	4.0	87.35%
5.00	3.803	3.239	5.0	85.15%

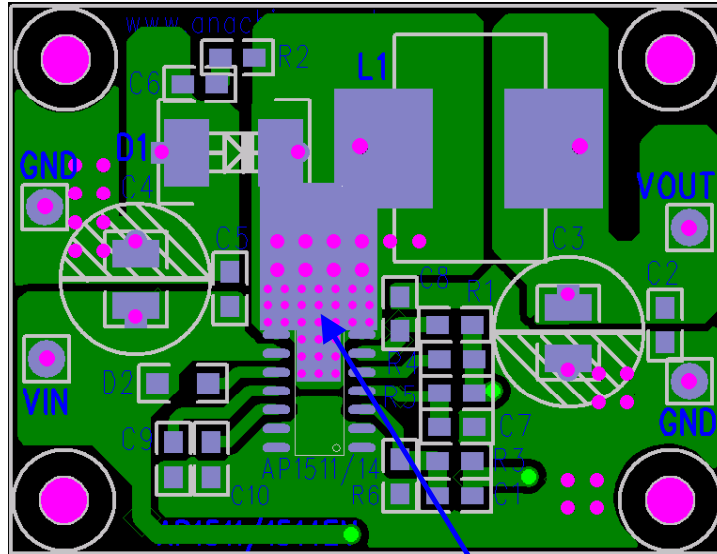
AP1511/AP1514 Temperature vs. Efficiency					
Parameter	Temperature (°C)				
	-20	0	25	50	85
$V_{in}$ (V)	12.03	12.06	12.07	12.14	12.16
$I_{in}$ (A)	0.334	0.327	0.323	0.320	0.318
$V_{out}$ (V)	3.43	3.41	3.39	3.37	3.34
$I_{out}$ (A)	1	1	1	1	1
Efficiency (%)	85.37	86.47	86.95	86.75	86.37



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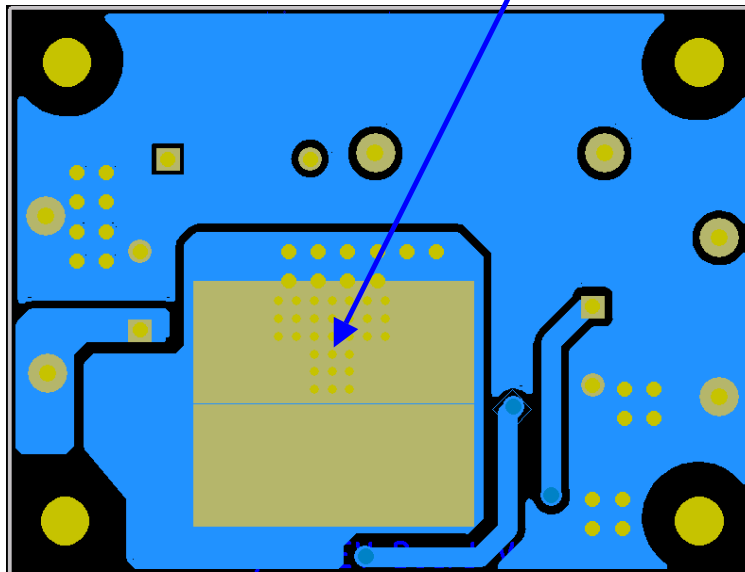
4.0.6 Typical PC Board Layout

(1). Top Side Layout Guide



Use vias to conduct the heat into the backside of PCB layer .  
The PCB heat sink copper area should be solder-painted  
without being masked. This approaches a “best case” pad heat

(2). Bottom Side Layout Guide



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**4.0.6 Typical PC Board Layout (continued)**

- A. Layout is very important in switching regulator design. The heavy current line should be wide printed circuit traces and should be kept as short as possible.
- B. The PC board layout should allow for maximum possible copper area at the Output pins of the AP1511/1514. The Output pins (7~9) on the SOP-16 package are internally connected, but lowest thermal resistance will result if these pins are tightly connected on the PC board. This will also aid heat dissipation at high power levels.
- C. The maximum power dissipation depends on the thermal resistance of IC package, PCB layout, the rate of surrounding airflow and temperature difference between junction to ambient. The maximum power dissipation can be calculated by the following formula:

$$P_{D(MAX)} = ( T_{J(MAX)} - T_A ) / \theta_{JA}$$

Where  $T_{J(MAX)}$  is the maximum operation junction temperature 125°C,  $T_A$  is the ambient temperature and the  $\theta_{JA}$  is the junction to ambient thermal resistance. For recommended operating conditions specification of AP1511/1514, where  $T_{J(MAX)}$  is the maximum junction temperature of the die (125°C) and  $T_A$  is the maximum ambient temperature. The junction to ambient thermal resistance  $\theta_{JA}$  is layout dependent. For SOP-16 packages, the thermal resistance  $\theta_{JA}$  is 50°C/W on the Multi-layer 2S demo board. The maximum power dissipation at  $T_A = 25^\circ\text{C}$  can be calculated by the following formula:

$$P_{D(MAX)} = ( 125^\circ\text{C} - 25^\circ\text{C} ) / 50 = 2.0 \text{ W for SOP-16 packages}$$

The maximum power dissipation depends on operating ambient temperature for fixed  $T_{J(MAX)}$  and thermal resistance  $\theta_{JA}$ .

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